# MPSW42

**Preferred Device** 

# One Watt High Voltage Transistor

# **NPN Silicon**

#### **Features**

• Pb-Free Packages are Available\*

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit	
Collector - Emitter Voltage	V <sub>CEO</sub>	300	Vdc	
Collector - Base Voltage	V <sub>CBO</sub>	300	Vdc	
Emitter - Base Voltage	V <sub>EBO</sub>	6.0	Vdc	
Collector Current – Continuous	I <sub>C</sub>	500	mAdc	
Total Device Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	1.0 8.0	W mW/°C	
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	$2 T_C = 25^{\circ}C$ $P_D$		W mW/°C	
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	

#### THERMAL CHARACTERISTICS

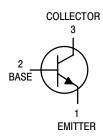
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	125	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	50	°C/W

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



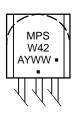
## ON Semiconductor®

#### http://onsemi.com



## MARKING DIAGRAM





MPSW42 = Device Code A = Assembly Location

Y = Year WW = Work Week ■ Pb-Free Package

(Note: Microdot may be in either location)

## ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
MPSW42	TO-92	5,000 Units/Box
MPSW42G	TO-92 (Pb-Free)	5,000 Units/Box
MPSW42RLRA	TO-92	2,000/Tape & Reel
MPSW42RLRAG	TO-92 (Pb-Free)	2,000/Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

**Preferred** devices are recommended choices for future use and best overall value.

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS	<u>.</u>			
Collector – Emitter Breakdown Voltage (Note 1) $(I_C = 1.0 \text{ mAdc}, I_B = 0)$	V <sub>(BR)</sub> CEO	300	_	Vdc
Collector-Base Breakdown Voltage $(I_C = 100 \mu Adc, I_E = 0)$	V <sub>(BR)</sub> CBO	300	_	Vdc
Emitter–Base Breakdown Voltage $(I_E = 100 \mu Adc, I_C = 0)$	V <sub>(BR)EBO</sub>	6.0	_	Vdc
Collector Cutoff Current (V <sub>CB</sub> = 200 Vdc, I <sub>E</sub> = 0)	I <sub>CBO</sub>	-	0.1	μAdc
Emitter Cutoff Current (V <sub>EB</sub> = 6.0 Vdc, I <sub>C</sub> = 0)	I <sub>EBO</sub>	-	0.1	μAdc
ON CHARACTERISTICS		•		•
DC Current Gain	h <sub>FE</sub>	25 40 40	_ _ _	-
Collector–Emitter Saturation Voltage (I <sub>C</sub> = 20 mAdc, I <sub>B</sub> = 2.0 mAdc)	V <sub>CE(sat)</sub>	-	0.5	Vdc
Base–Emitter Saturation Voltage ( $I_C = 20 \text{ mAdc}$ , $I_B = 2.0 \text{ mAdc}$ )	V <sub>BE(sat)</sub>	-	0.9	Vdc
SMALL-SIGNAL CHARACTERISTICS		•		•
Current-Gain - Bandwidth Product (I <sub>C</sub> = 10 mAdc, V <sub>CE</sub> = 20 Vdc, f = 20 MHz)	f <sub>T</sub>	50	_	MHz
Collector Capacitance (V <sub>CB</sub> = 20 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)	C <sub>cb</sub>	-	3.0	pF

 $<sup>(</sup>V_{CB} = 20 \text{ Vdc}, I_E = 0, f = 1.0 \text{ MHz})$ 1. Pulse Test: Pulse Width  $\leq 300 \text{ μs}$ , Duty Cycle  $\leq 2.0\%$ .

# MPSW42

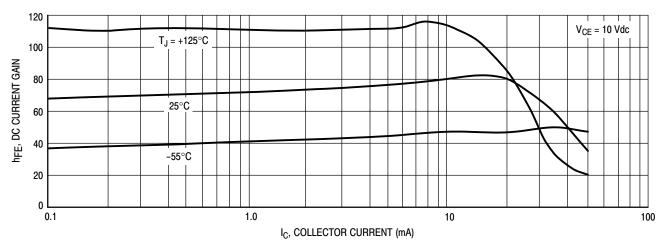


Figure 1. DC Current Gain

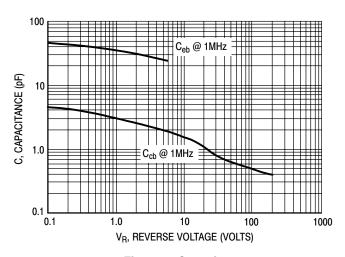


Figure 2. Capacitance

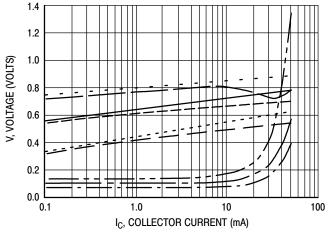
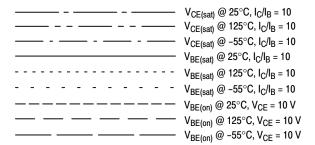


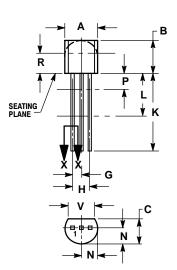
Figure 3. "ON" Voltages



## MPSW42

#### PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-11 **ISSUE AL** 





#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 114-3M, 1902.
  CONTROLLING DIMENSION: INCH.
  CONTOUR OF PACKAGE BEYOND DIMENSION R
  IS UNCONTROLLED.
  LEAD DIMENSION IS UNCONTROLLED IN P AND
- BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
С	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
P		0.100		2.54
R	0.115		2.93	
v	0 135		3 43	

STYLE 1:

PIN 1. EMITTER

BASE 2.

COLLECTOR

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